TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSIII)

TPC6004

Notebook PC Applications Portable Equipment Applications

- Low drain-source ON resistance: RDS (ON) = 19 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 11 \text{ S (typ.)}$
- Low leakage current: IDSS = 10 µA (max) (VDS = 20 V)
- Enhancement mode: V_{th} = 0.5 to 1.2 V (V_{DS} = 10 V, I_{D} = 200 μA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	20	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V _{DGR}	20	V	
Gate-source voltage		V _{GSS}	±12	V	
Drain current	DC (Note 1)	I _D	6	А	
Drain current	Pulse (Note 1)	I _{DP}	24		
Drain power dissipation	(t = 5 s) (Note 2a)	P_{D}	2.2	W	
Drain power dissipation	(t = 5 s) (Note 2b)	P_{D}	0.7	W	
Single pulse avalanche energy (Note 3)		E _{AS}	5.8	mJ	
Avalanche current	I _{AR}	3	Α		
Repetitive avalanche energ	E _{AR}	0.22	mJ		
Channel temperature	T _{ch}	150	°C		
Storage temperature range		T _{stg}	-55 to 150	°C	

Unit: mm

6

10.95 0.95 3

2.9 ± 0.2

10.95 0.95 3

2.9 ± 0.2

10.25 0.25 0.15

1. Drain
2. Drain
3. Gate

5. Drain
3. Gate

6. Drain

JEDEC

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JEITA

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TOSHIBA

2-3T1A

Weight: 0.011 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

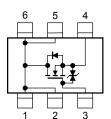
Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient $(t = 5 \text{ s})$ (Note 2a)	R _{th (ch-a)}	56.8	°C/W
Thermal resistance, channel to ambient $(t=5\ s)$ (Note 2b)	R _{th (ch-a)}	178.5	°C/W

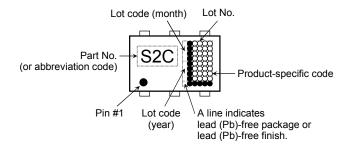
Note: (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5): See the next page.

This transistor is an electrostatic-sensitive device. Please handle with caution.

Circuit Configuration



Marking (Note 5)



Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cut-OFF cu	ırrent	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V	_	_	10	μА
Drain-source breakdown voltage		V _{(BR)DSS}	$I_D = 10$ mA, $V_{GS} = 0$ V	20	_	_	V
		V _{(BR)DSX}	$I_D = 10 \text{ mA}, V_{GS} = -12 \text{ V}$	8	_	_	
Gate threshold vo	oltage	V _{th}	$V_{DS} = 10 \text{ V}, I_D = 200 \mu\text{A}$	0.5	_	1.2	V
			$V_{GS} = 2.0 \text{ V}, I_D = 3 \text{ A}$	_	30	37	
Drain-source ON resistance	R _{DS (ON)}	V _{GS} = 2.5 V, I _D = 3 A	_	25	32	mΩ	
			V _{GS} = 4.5 V, I _D = 3 A	_	19	24	
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 3 A	5.5	11	_	S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	1400	_	pF
Reverse transfer capacitance		C _{rss}		_	165	_	
Output capacitance		Coss]	_	180	_	
Switching time	Rise time	tr	V_{GS} $\stackrel{5}{\overset{\circ}{\overset{\circ}{\overset{\circ}{\overset{\circ}{\overset{\circ}{\overset{\circ}{\overset{\circ}{\overset$	_	5	_	- ns
	Turn-ON time	t _{on}		_	10	_	
	Fall time	t _f		_	14	_	
	Turn-OFF time	t _{off}		_	60	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	17		nC
Gate-source charge		Q _{gs}	$V_{DD} \simeq 16 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 6 \text{ A}$	_	13	_	
Gate-drain ("miller") charge		Q _{gd}	1	_	4	_	

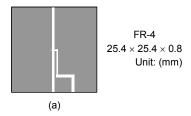
Source-Drain Ratings and Characteristics (Ta = 25°C)

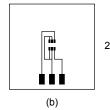
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Pulse drain reverse current (No	e 1)	I _{DRP}	_	_	_	24	Α
Forward voltage (Diode)		V _{DSF}	I _{DR} = 6 A, V _{GS} = 0 V	_	_	-1.2	V

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)



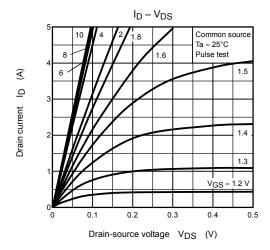


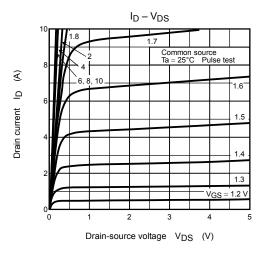
FR-4 $25.4 \times 25.4 \times 0.8$ Unit: (mm)

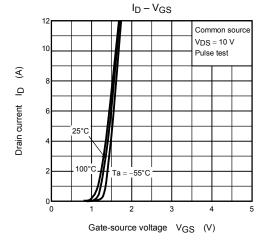
Note 3: V_{DD} = 16 V, T_{ch} = 25°C (initial), L = 0.5 mH, R_G = 25 Ω , I_{AR} = 3.0 A

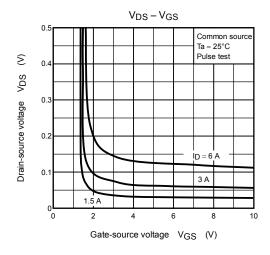
Note 4: Repetitive rating: pulse width limited by maximum channel temperature

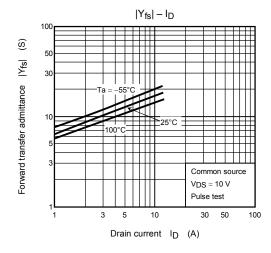
Note 5: • on lower left of the marking indicates Pin 1.

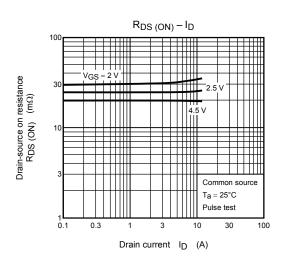




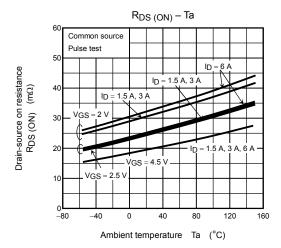


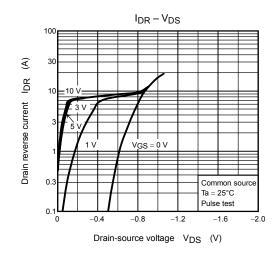


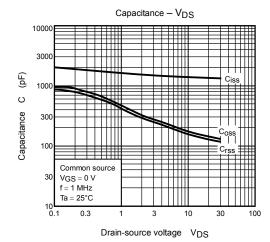


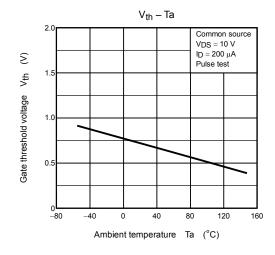


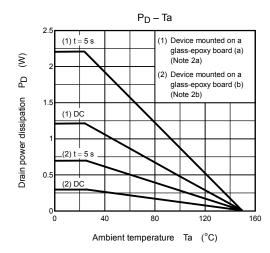
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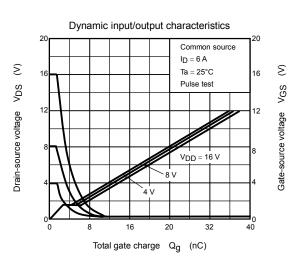


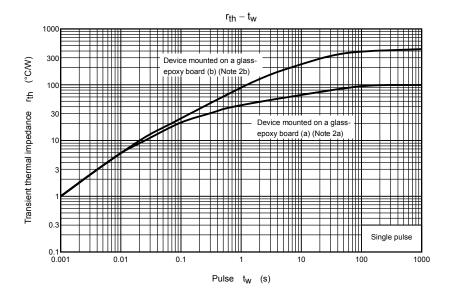


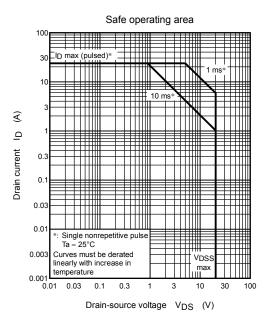












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